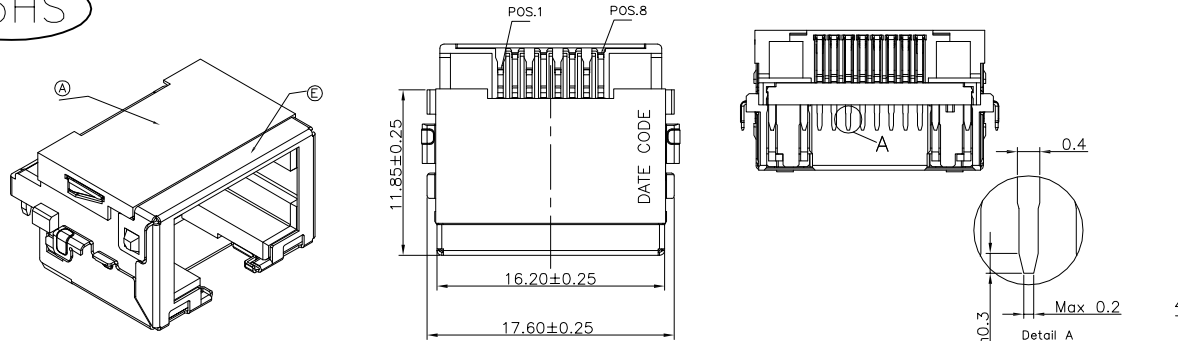
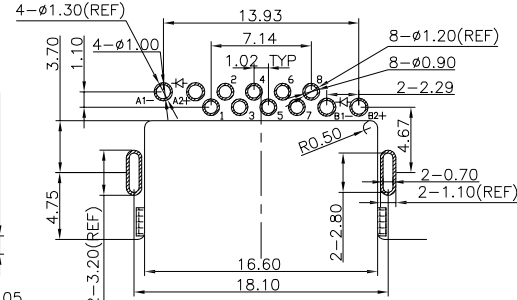
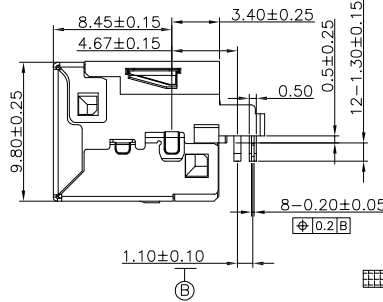
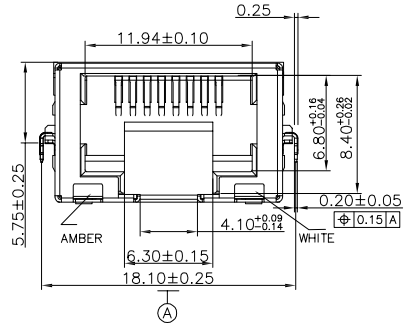
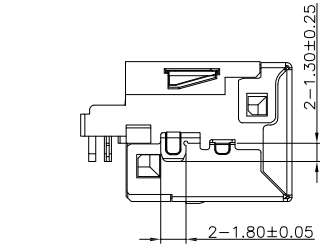


The product using material and processing must conform to the "WL-PZ-001"HSF technical standard control requirements

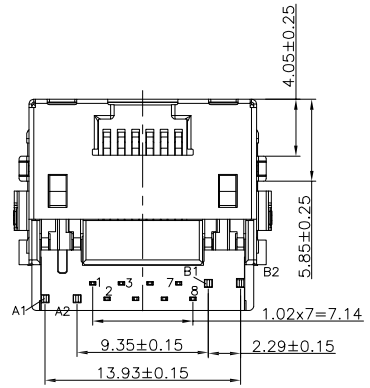
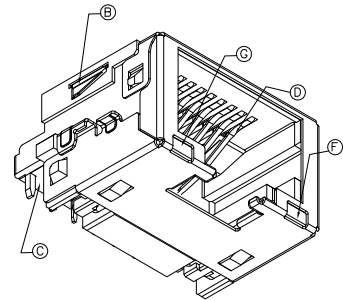
RoHS



- NOTES:  
 1.MATERIAL: SEE SHEET  
 2. FINISH:  
 2.1 TERMINAL: NICKEL UNDERPLATING OVER ALL.GOLD FLASH ON CONTACT AREA, MATTE TIN 100u" ON SOLDER AREA.  
 2.2 SHELL:UNDERPLATED: NICKEL PLATING OVER ALL.  
 3. HALOGEN FREE & RoHS COMPLIANT PRODUCTS.  
 4. FOR IR SOLDERING LEAD-FREE PROCESS.260°C, 5~10SECS.



RECOMMENDED P.C BOARD LAYOUT  
 (TOP SIDE) TOLERANCE=±0.05mm PCB T=1.2mm  
 [Grid] PATTERN PROHIBITED AREA [Hatched] PATTERN SOLDER AREA



5.P/N: WL R4 F 9-08 1 1 A 0 098  
 CONNECTOR: R4-RJ45  
 MALE FEMALE: F-FEMALE  
 ANGLE: 9-90°  
 PIN Q'PY: 08PIN  
 COLOR: A-BLACK  
 PLATING: 1-G/F, 2-AU 3U", 6-AU 30U"  
 TERMPIPOINT: 1-DIP

LED ELECTRIC CHARACTERISTIC	
AMBER	A1(-) ↔ A2(+)
WHITE	B1(-) ↔ B2(+)

ITEM	DESCRIPTION	REMARK	Q'TY
Ⓒ	LED	EPOXY RESIN AMBER	1
Ⓕ	LED	EPOXY RESIN WHITE	1
Ⓔ	SPACER	HIGH TEMP THERMOPLASTIC, ,UL94V-0, BLACK	1
Ⓖ	STOPPER	HIGH TEMP THERMOPLASTIC, ,UL94V-0, BLACK	2
Ⓒ	SHELL	METAL ALLOY , Ni PLATING	1
Ⓑ	CONTACT	COPPER ALLOY , GOLD PLATING ON CONTACT AREA	1 SET
Ⓐ	HOUSING	HIGH TEMP THERMOPLASTIC, ,UL94V-0, BLACK	1

REV.	REVISION RECORD	DATE	GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:	 WanLian Teconology Co., Ltd	
AO	NEW RELEASE	22.05.09	LINEAR	ANGLES	1:1	Wang_jr	22.05.09	WLR4F9-0811A0098	ENDE05		
			UNIT:mm	X'±3'	APPROVED	Han_Gao	22.05.09	TITLE:		REV: A0	SHEET: 1/1
			SIZE: A4	X'X' ±2'	DESIGNER	LanXuan_Hou	22.05.09	CONN, RJ45 RECEPTACLE REVERSE RA DIP, W/LED, H=5.75mm			